| Symbol | Parameter | Value | Unit |
|------------------|--------------------------------------|------------|------|
| P _{tot} | Total Dissipation at T_{C} = 25 °C | 70 | W |
| T _{stg} | Storage Temperature | -65 to 150 | °C |
| TJ | Max. Operating Junction Temperature | 150 | °C |

Table 3: Thermal Data

| R _{thj-case} | Thermal Resistance Junction-Case | Max | 1.78 | °C/W |
|-----------------------|-------------------------------------|-----|------|------|
| R _{thj-amb} | Thermal Resistance Junction-Ambient | Max | 62.5 | °C/W |

Table 4: Electrical Characteristics (T_{case} = 25 ^oC unless otherwise specified)

| Symbol | Parameter | 1 | Min. | Тур. | Max. | Unit | |
|-------------------------|---|-------------------------|--------------------------|------|------|------|----|
| I _{CES} | Collector Cut-off Current | V _{CE} = 700 V | | | | 100 | μA |
| | (V _{BE} = 0 V) | V _{CE} =700 V | T _j = 125 °C | | | 500 | μA |
| I _{CEO} | Collector Cut-off Current | V _{CE} = 400 V | | | | 250 | μA |
| | (I _B = 0) | | | | | | |
| V _{(BR)EBO} | Emitter-Base Breakdown Voltage | I _E = 10 mA | | 9 | | 18 | V |
| | $(I_{\rm C} = 0)$ | | | | | | |
| V _{CEO(sus)} * | Collector-Emitter Sustaining Voltage | I _C = 100 mA | L = 25 mH | 400 | | | V |
| | (I _B = 0) | | | | | | |
| V _{CE(sat)} * | Collector-Emitter | I _C = 0.5 A | I _B = 0.1 A | | | 0.7 | V |
| S | Saturation Voltage | I _C = 1 A | I _B = 0.2 A | | | 1 | V |
| | | I _C = 2.5 A | I _B = 0.5 A | | | 1.5 | V |
| | | I _C = 4 A | I _B = 1 A | | 0.5 | | V |
| V _{BE(sat)} * | Base-Emitter Saturation | I _C = 0.5 A | I _B = 0.1 A | | | 1.1 | V |
| | Voltage | I _C = 1 A | I _B = 0.2 A | | | 1.2 | V |
| | | I _C = 2.5 A | I _B = 0.5 A | | | 1.3 | V |
| h _{FE} * | DC Current Gain | I _C = 10 mA | V _{CE} = 5 V | 10 | | | |
| | | I _C = 2 A | V _{CE} = 5 V | 12 | | 32 | |
| | RESISTIVE LOAD | V _{CC} =200 V | I _C = 2 A | | | | |
| t _s | Storage Time | I _{B1} = 0.4 A | $V_{BE(off)}$ = -5 V | | 0.6 | | μs |
| t _f | Fall Time | R_{BB} = 0 Ω | L = 200 μH | | 0.1 | | μs |
| | | (see figure 15) |) | | | | |
| | INDUCTIVE LOAD | V _{CC} =250 V | I _C = 2 A | | | | |
| t _s | Storage Time | I _{B1} = 0.4 A | I _{B2} = -0.4 A | 2 | | 2.9 | μs |
| t _f | Fall Time | Tp = 30 µs | (see figure 14) | | 0.2 | | μs |

* Pulsed: Pulsed duration = 300 μ s, duty cycle \leq 1.5 %.

.

Figure 3: Safe Operating Area



Figure 4: DC Current Gain





Figure 6: Derating Current



Figure 7: DC Current Gain









Figure 9: Inductive Load Fall Time





Figure 11: Reverse Biased Operating Area







Figure 13: Resistive Load Stoarage Time



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Figure 14: Inductive Load Switching Test Circuit



Table 15: Restistive Load Switching Test Circuit





| DIM. | mm. | | | inch | | | |
|------|-------|-------|-------|-------|-------|-------|--|
| | MIN. | TYP | MAX. | MIN. | TYP. | MAX. | |
| А | 4.40 | | 4.60 | 0.173 | | 0.181 | |
| b | 0.61 | | 0.88 | 0.024 | | 0.034 | |
| b1 | 1.15 | | 1.70 | 0.045 | | 0.066 | |
| С | 0.49 | | 0.70 | 0.019 | | 0.027 | |
| D | 15.25 | | 15.75 | 0.60 | | 0.620 | |
| E | 10 | | 10.40 | 0.393 | | 0.409 | |
| е | 2.40 | | 2.70 | 0.094 | | 0.106 | |
| e1 | 4.95 | | 5.15 | 0.194 | | 0.202 | |
| F | 1.23 | | 1.32 | 0.048 | | 0.052 | |
| H1 | 6.20 | | 6.60 | 0.244 | | 0.256 | |
| J1 | 2.40 | | 2.72 | 0.094 | | 0.107 | |
| L | 13 | | 14 | 0.511 | | 0.551 | |
| L1 | 3.50 | | 3.93 | 0.137 | | 0.154 | |
| L20 | | 16.40 | | | 0.645 | | |
| L30 | 1 | 28.90 | | | 1.137 | | |
| øP | 3.75 | | 3.85 | 0.147 | | 0.151 | |
| Q | 2.65 | | 2.95 | 0.104 | | 0.116 | |





Table 5:

| Version | Release Date | Change Designator |
|-------------|--------------|--------------------------|
| 01-Oct-2002 | 1 | First Release. |
| 15-Feb-2005 | 1 | Added table 1 on page 1. |



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